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Kind regards,

Team Nexperia



Ultra low capacitance unidirectional ESD protection diode

Rev. 1 — 15 February 2011

Product data sheet

1. Product profile

1.1 General description

Ultra low capacitance unidirectional ElectroStatic Discharge (ESD) protection diode designed to protect one signal line from the damage caused by ESD and other transients. The device is housed in a SOD882D leadless ultra small Surface-Mounted Device (SMD) plastic package with visible and solderable side pads.

The combination of extremely low capacitance and ultra low clamping voltage makes the device ideal for high-speed data line protection applications.

1.2 Features and benefits

- ESD protection of one line
- Ultra low diode capacitance C_d = 0.95 pF
- Ultra low clamping voltage: V_{CL} = 8 V
- Ultra low leakage current: I_{RM} = 1 nA
- ESD protection up to 8 kV

1.3 Applications

- Computers and peripherals
- Audio and video equipment
- Cellular handsets and accessories
- 10/100/1000 Mbit/s Ethernet
- Communication systems

1.4 Quick reference data

Table 1. Quick reference data

- IEC 61000-4-2; level 4 (ESD)
- Ultra small SMD plastic package
- Solderable tin-plated side pads
- AEC-Q101 qualified
- Portable electronics
- Subscriber Identity Module (SIM) card protection
- USB, High-Definition Multimedia Interface (HDMI), FireWire
- High-speed data lines

Parameter	Conditions	Min	Тур	Max	Unit
reverse standoff voltage		-	-	5.5	V
diode capacitance	$f = 1 MHz; V_R = 0 V$	-	0.95	1.1	pF
	Parameter reverse standoff voltage	Parameter Conditions reverse standoff voltage	ParameterConditionsMinreverse standoff voltage-	ParameterConditionsMinTypreverse standoff voltage	ParameterConditionsMinTypMaxreverse standoff voltage5.5



Ultra low capacitance unidirectional ESD protection diode

Pinning information 2.

Pin	Description	Simplified outline	Graphic symbol
1	cathode	[1]	
2	anode		1 2 006aaa152
		Transparent top view	

Ordering information 3.

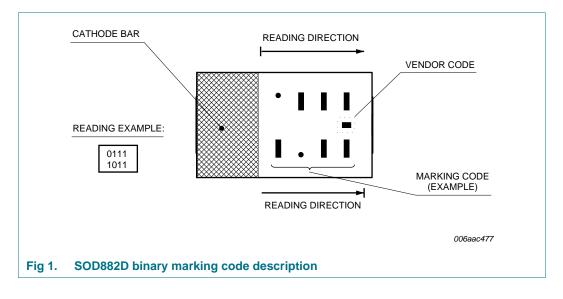
Table 3. Ordering	g information	on	
Type number	Package		
	Name	Description	Version
PESD5V0X1ULD	-	leadless ultra small plastic package; 2 terminals; body 1 \times 0.6 \times 0.4 mm	SOD882D

Marking 4.

Table 4. Marking codes	
Type number	Marking code ^[1]
PESD5V0X1ULD	1111 0000

[1] For SOD882D binary marking code description, see Figure 1.

4.1 Binary marking code description



PESD5V0X1ULD **Product data sheet**

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5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
I _{PP}	peak pulse current	$t_p = 8/20 \ \mu s$	<u>[1][2]</u> _	1.5	А
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-55	+150	°C
T _{stg}	storage temperature		-65	+150	°C

[1] Non-repetitive current pulse 8/20 µs exponential decay waveform according to IEC 61000-4-5.

[2] Measured from pin 1 to 2.

Table 6. ESD maximum ratings

 $T_{amb} = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Max	Unit
V _{ESD} electrostatic discharge voltage		IEC 61000-4-2 (contact discharge)	<u>[1][2]</u> _	8	kV
	machine model	-	400	V	
		MIL-STD-883 (human body model)	[2] _	10	kV

[1] Device stressed with ten non-repetitive ESD pulses.

[2] Measured from pin 1 to 2.

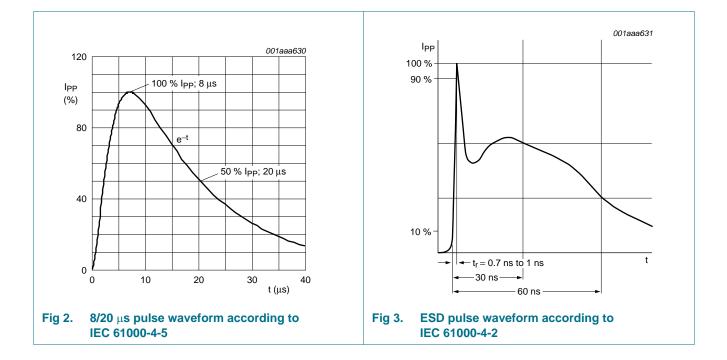
Table 7. ESD standards compliance

Standard	Conditions
IEC 61000-4-2; level 4 (ESD)	> 15 kV (air); > 8 kV (contact)
MIL-STD-883; class 3 (human body model)	> 4 kV

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6. Characteristics

Table 8. Characteristics

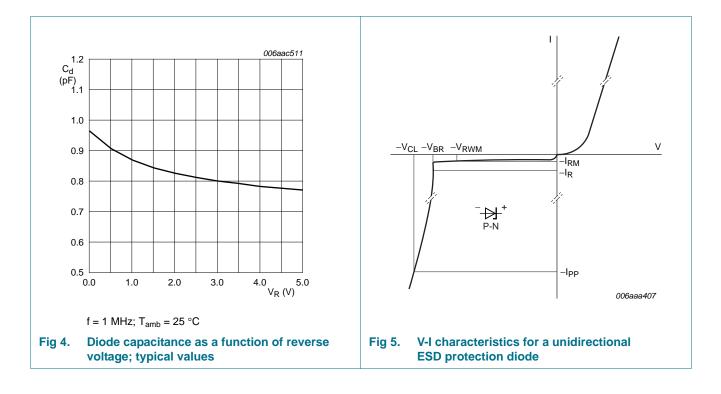
 $T_{amb} = 25 \ ^{\circ}C$ unless otherwise specified.

Symbol	Parameter	Conditions	I	Min	Тур	Max	Unit
V _{RWM}	reverse standoff voltage		-	•	-	5.5	V
I _{RM}	reverse leakage current	$V_{RWM} = 5 V$	-	•	1	100	nA
V_{BR}	breakdown voltage	I _R = 10 mA	Ę	5.8	7.5	10	V
C _d	diode capacitance	$f = 1 MHz; V_R = 0 V$	-	•	0.95	1.1	pF
V _{CL}	clamping voltage	I _{PP} = 1.5 A	[1][2]	•	8	-	V
r _{dyn}	dynamic resistance	I _R = 10 A	[3]	•	0.25	-	Ω

[1] Non-repetitive current pulse 8/20 µs exponential decay waveform according to IEC 61000-4-5.

[2] Measured from pin 1 to 2.

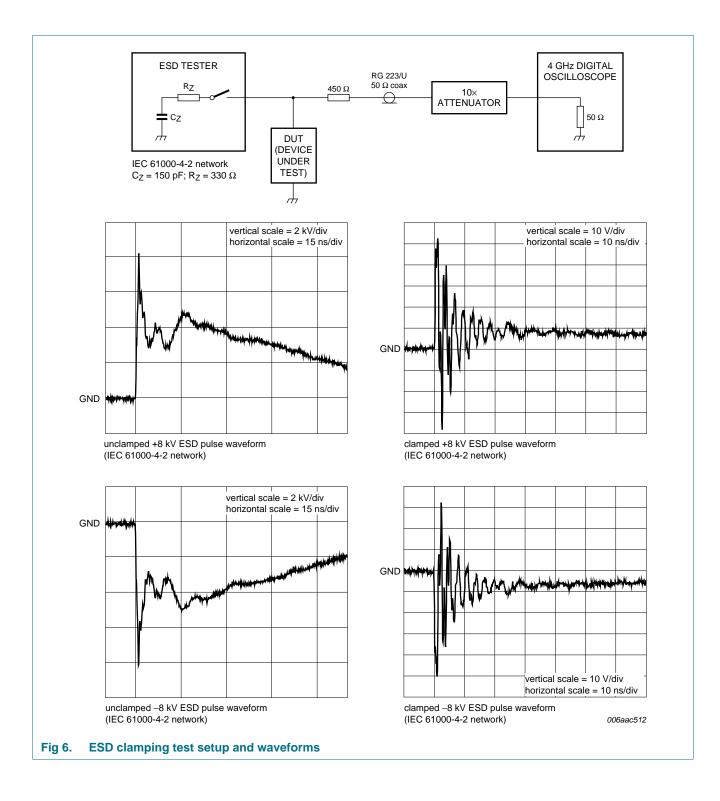
[3] Non-repetitive current pulse, Transmission Line Pulse (TLP) t_p = 100 ns; square pulse; ANS/IESD STM5-1-2008.



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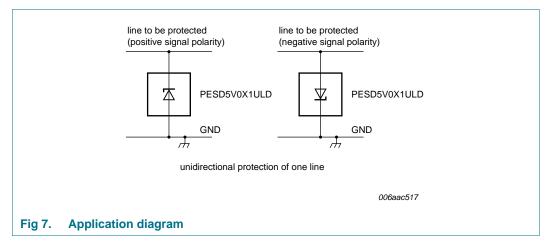


PESD5V0X1ULD

Ultra low capacitance unidirectional ESD protection diode

7. Application information

The PESD5V0X1ULD is designed for the protection of one unidirectional data or signal line from the damage caused by ESD and surge pulses. The device may be used on lines where the signal polarities are either positive or negative with respect to ground.



Circuit board layout and protection device placement

Circuit board layout is critical for the suppression of ESD, Electrical Fast Transient (EFT) and surge transients. The following guidelines are recommended:

- 1. Place the PESD5V0X1ULD as close to the input terminal or connector as possible.
- The path length between the PESD5V0X1ULD and the protected line should be minimized.
- 3. Keep parallel signal paths to a minimum.
- 4. Avoid running protected conductors in parallel with unprotected conductors.
- 5. Minimize all Printed-Circuit Board (PCB) conductive loops including power and ground loops.
- 6. Minimize the length of the transient return path to ground.
- 7. Avoid using shared transient return paths to a common ground point.
- 8. Ground planes should be used whenever possible. For multilayer PCBs, use ground vias.

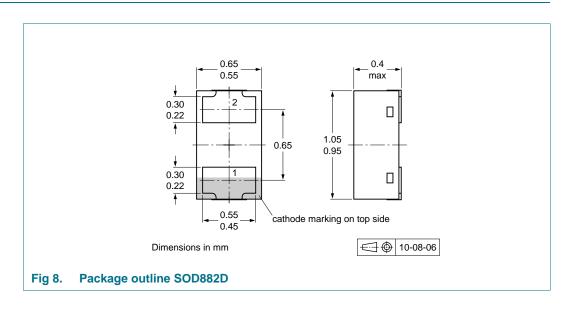
8. Test information

8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

Ultra low capacitance unidirectional ESD protection diode

9. Package outline



10. Packing information

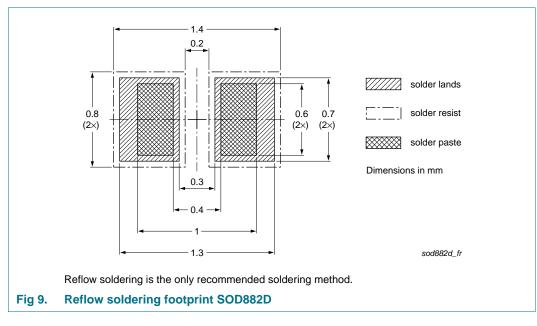
Table 9. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing quantity
			10000
PESD5V0X1ULD	SOD882D	2 mm pitch, 8 mm tape and reel	-315

[1] For further information and the availability of packing methods, see <u>Section 14</u>.

11. Soldering



PESD5V0X1ULD

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12. Revision history

Table 10. Revision hist	ory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
PESD5V0X1ULD v.1	20110215	Product data sheet	-	-

13. Legal information

13.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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PESD5V0X1ULD

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